LITEON Lite-On Technology Corporation

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LED LAMP

LTL3H3ENADS-132A

DATA SHEET

LITE-ON ENG.

Sep./10/2013

PRELIMINARY

SPEC NO :

EFFECTIVE :

CREATED :

Sep./10/2013

А

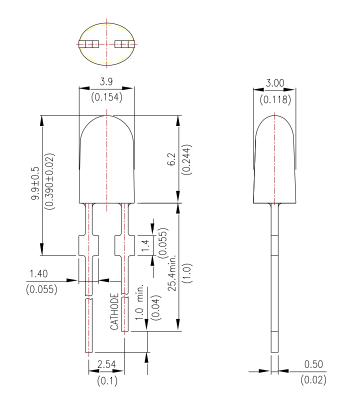
REV. NO:

Property of Lite-On Only

Features

- * High Luminous intensity output.
- * Low power consumption.
- * High efficiency.
- * Wide Viewing Angle
- Major Axis 100° / Minor Axis 45°
- * Versatile mounting on P.C. board or panel.
- * I.C. Compatible/low current requirements.

Package Dimensions



Part No.	Lens	Source Color
LTL3H3ENADS	Red Diffused	AlInGaP Red

Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ± 0.25 mm(.010") unless otherwise noted.
- 3. Protruded resin under flange is 1.0mm(.04") max.
- 4. Lead spacing is measured where the leads emerge from the package.
- 5. Specifications are subject to change without notice.

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Absolute Maximum Ratings at TA=25°C

Parameter	Maximum Rating		
Power Dissipation	75		
Peak Forward Current (Duty Cycle $\leq 1/10$, Pulse Width ≤ 10 ms)	100 mA		
DC Forward Current	30		
Derating Linear From 50°C	0.51	mA/°C	
Reverse Voltage	5		
Operating Temperature Range	-30°C to + 85°C		
Storage Temperature Range	-40°C to + 100°C		
Lead Soldering Temperature [2.0mm (.079") From Body]	260°C for 5 Seconds Max.		



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Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	Iv	680	1000	1500	mcd	$I_F = 20mA$ Note 1,5
Viewing Angle	2 heta 1/2		100 / 45		deg	Note 2 (Fig.6)
Peak Emission Wavelength	λ Ρ		630		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λd	618	624	629	nm	Note 4
Spectral Line Half-Width	Δλ		20		nm	
Forward Voltage	VF	1.8	2.4	2.6	V	$I_F = 20 m A$
Reverse Current	Ir			50	μA	$V_R = 5V$

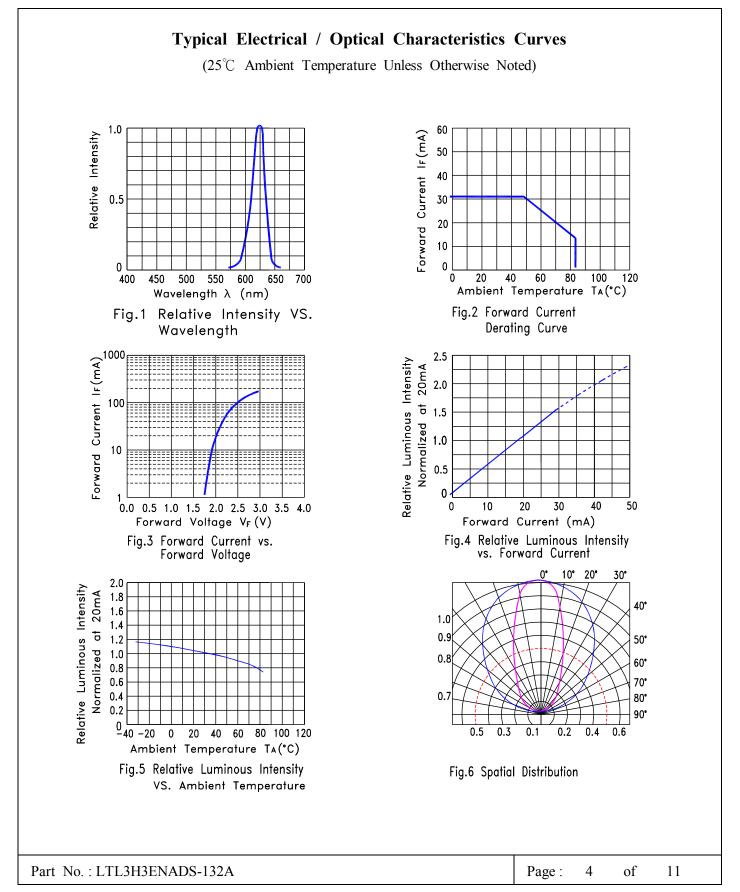
NOTE: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. Iv classification code is marked on each packing bag.
- 4. The dominant wavelength, λ d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 5. Iv guarantee must be included with $\pm 15\%$ testing tolerance.
- 6. Reverse voltage (VR) condition is applied for IR test only. The device is not designed for reverse operation.

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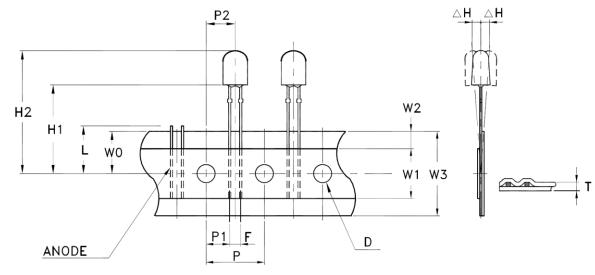
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Features

- * Compatible with radial lead automatic insertion equipment.
- * Most radial lead plastic lead lamps available packaged in tape and folding.
- * 2.54mm (0.1") straight lead spacing available.
- * Folding packaging simplifies handling and testing. Reel packaging is available by removing suffix "A" on option.

Package Dimensions

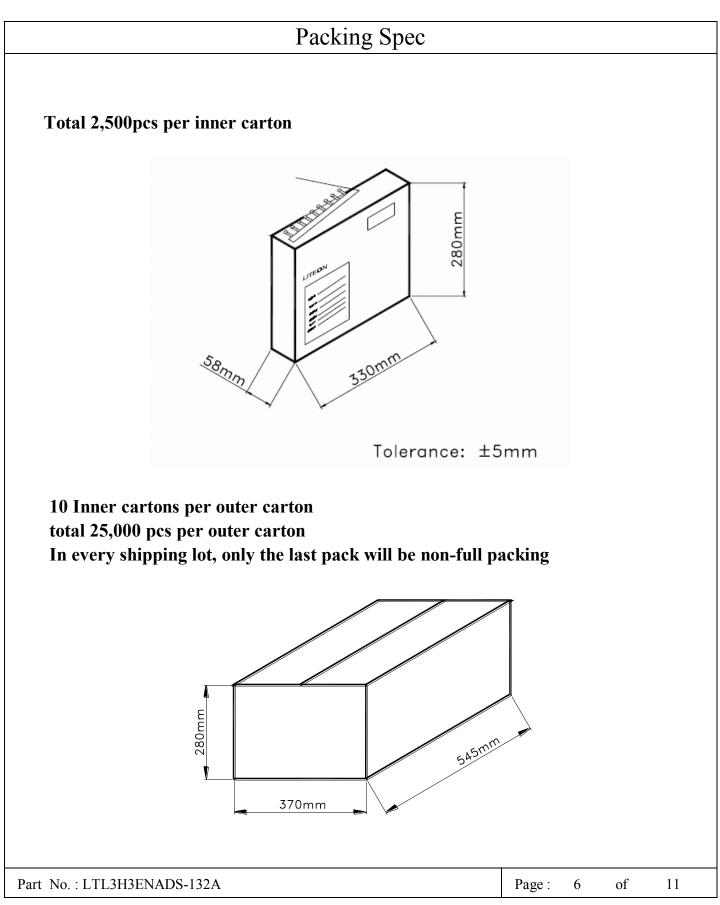


TAPE FEED DIRECTION

			Specif	ication	
Item	Symbol	Minimum		Maximum	
		mm	inch	mm	inch
Tape Feed Hole Diameter	D	3.8	0.149	4.2	0.165
Component Lead Pitch	F	2.3	0.091	3.0	0.118
Front to Rear Deflection	$\triangle H$			2.0	0.078
Feed Hole to Bottom of Component	H1	20.0	0.787	21.0	0.827
Feed Hole to Overall Component Height	H2	26.0	1.061	27.5	1.083
Lead Length After Component Height	L	W0		11.0	0.433
Feed Hole Pitch	Р	12.4	0.488	13.0	0.511
Lead Location	P1	4.4	0.173	5.8	0.228
Center of Component Location	P2	5.05	0.198	7.65	0.301
Total Tape Thickness	Т			0.90	0.035
Feed Hole Location	W0	8.5	0.334	9.75	0.384
Adhesive Tape Position	W2	0	0	3.0	0.118
Tape Width	W3	17.5	0.689	19.0	0.748
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Luminous	s Intensity Iv(mcd)	IF@20mA
Bin Code	Min.	Max.
N	680	880
P	880	1150
<mark>Q</mark>	1150	1500

Note: Tolerance of each bin limit is $\pm 15\%$

Dominant Wavelength Unit : nm @20mA				
Bin Code	Bin Code	Bin Code		
R1	618	629		

Note: Tolerance of each bin limit is ± 1 nm

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CAUTIONS

1. Application

This LED lamp is good for application of indoor and outdoor sign, also ordinary electronic equipment.

2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens. Do not use the base of the lead frame as a fulcrum during forming.

Lead forming must be done before soldering, at normal temperature.

During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

5. Soldering

When soldering, leave a minimum of 3mm clearance from the base of the lens to the soldering point. Dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature. Recommended soldering conditions :

Soldering iron		Wave soldering		
Temperature	350°C Max.	Pre-heat	100°C Max.	
Soldering time	3 seconds Max.	Pre-heat time	60 seconds Max.	
	(one time only)	Solder wave	260°C Max.	
Position	No closer than 3mm	Soldering time	5 seconds Max.	
	from the base of the epoxy bulb	Dipping Position	No lower than 3mm from the	
			base of the epoxy bulb	

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED. IR reflow is not suitable process for through hole type LED lamp product.

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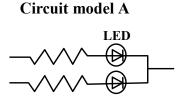
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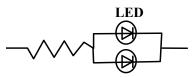
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6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.



Circuit model B



- (A) Recommended circuit
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs

7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

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Suggested checking list :

Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 5. All wrist strap or heel strap checkers calibration up to date? Note: *50V for Blue LED.

Device Handling

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?

4. All flexible conductive and dissipative package materials inspected before reuse or recycle? Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

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Classification	Test Item	Test Condition	Sample Size	Reference Standard	
		Ta = 25°C	45 PCS	MIL-STD-750D:1026 (1995)	
Endurance	Operation Life	IF = 30mA	(CL=90%;	MIL-STD-883G:1005 (2006)	
		*Test Time= 1000hrs	LTPD=5%)	WIE-01D-0000.1003 (2000)	
	High Temperature/	Ta = 85°C	45 PCS	MIL-STD-202G:103B (2002)	
	High Humidity	RH = 85%	(CL=90%;	JEITA ED-4701:100 103	
	storage (THB)	*Test Time= 1000hrs	LTPD=5%)	(2001)	
	Steady state	Ta = 85°C, RH= 85 %	76 PCS		
	Operation Life of	IF = 15mA	(CL=90%;	JESD22-A101C (2009)	
	High Humidity Heat	*Test Time= 500hrs	LTPD=3%)		
	Low Temperature	Ta = -30°C	45 PCS		
Test	Operation Life of	IF = 30mA			
		*Test Time= 1000hrs	(CL=90%; LTPD=5%)		
			,	MIL-STD-750D:1031 (1995)	
	Llich Tomporature	Ta= 105 ± 5°C	45 PCS		
	High Temperature Storage	*Test Time= 1000brs	(CL=90%;	MIL-STD-883G:1008 (2006	
			LTPD=5%)	JEITA ED-4701:200 201 (2001)	
		T	45 PCS		
	Low Temperature	Ta= -55 ± 5°C	(CL=90%;	JEITA ED-4701:200 202 (2001)	
	Storage	*Test Time= 1000hrs	LTPD=5%)	(2001)	
		$100^{\circ}\text{C} \sim 25^{\circ}\text{C} \sim -40^{\circ}\text{C} \sim 25^{\circ}\text{C}$	70 000	MIL-STD-750D:1051 (1995)	
	Temperature		76 PCS	MIL-STD-883G:1010 (2006)	
	Cycling	30mins 5mins 30mins 5mins	(CL=90%; LTPD=3%)	JEITA ED-4701:100 105 (2001)	
		*Test time: 200 Cycles	ETT D=370)	JESD22-A104C (2005)	
		$100 \pm 5^{\circ}C \sim -30^{\circ}C \pm 5^{\circ}C$		MIL-STD-750D:1056 (1995)	
	Thermal	15mins 15mins	76 PCS	MIL-STD-883G:1011 (2006)	
	Shock	*Test time: 200 Cycles	(CL=90%; LTPD=3%)	MIL-STD-202G:107G (2002)	
		(<20 secs transfer)	LIPD=3%)	JESD22-A106B (2004)	
, ,		T.sol = 260 ± 5°C			
Environmental Test	Solder Resistance	Dwell Time= 10±1 seconds	11 PCS	MIL-STD-750D:2031(1995)	
		3mm from the base of the epoxy	(CL=90%;	JEITA ED-4701: 300 302 (2001	
		bulb	LTPD=18.9%)		
		T. sol = 245 ± 5°C		MIL-STD-750D:2026 (1995)	
	Solderability	Dwell Time= 5 ± 0.5 seconds	11 PCS	MIL-STD-883G:2003 (2006)	
		(Lead Free Solder, Coverage	(CL=90%; LTPD=18.9%)	MIL-STD-202G:208H (2002)	
		\geq 95% of the dipped surface)	L I D - 10.370)	IPC/EIA J-STD-002 (2004)	
		T. sol = 350 ± 5°C	11 PCS	MIL-STD-202G:208H (2002)	
	Soldering Iron	Dwell Time= 3.5 ± 0.5 seconds	(CL=90%;LTPD	JEITA ED-4701:300 302 (2001)	
			=18.9%)		

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